

Silicon Carbide Power MOSFET C3M[™] MOSFET Technology N-Channel Enhancement Mode

Features

- 3rd Generation SiC MOSFET technology
- High blocking voltage with low on-resistance
- High speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Qrr)
- Halogen free, RoHS compliant

Benefits

- Higher system efficiency
- Reduced cooling requirements
- Increased power density
- Increased system switching frequency
- Easy to parallel and simple to drive
- Enable new hard switching PFC topologies (Totem-Pole)

Applications

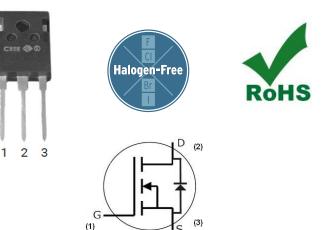
- EV charging
- Solar PV Inverters
- UPS
- SMPS
- DC/DC converters

Maximum Ratings (T_c=25°C, unless otherwise specified)

| Symbol | Parameter | Value | Unit | Note |
|-----------------------------------|---|----------|--------------|-------------------|
| V _{DSmax} | Drain - Source Voltage | 650 | V | |
| V_{GSmax} | Gate - Source voltage | -8/+19 | V | Note 1 |
| | Continuous Drain Current, $V_{GS} = 15 \text{ V}$, $T_C = 25^{\circ}\text{C}$ | 120 | | Fig. 19 Note 2 |
| ID | Continuous Drain Current, $V_{GS} = 15 \text{ V}$, $T_C = 100^{\circ}\text{C}$ | 96 | | |
| I _{D(pulse)} | Pulsed Drain Current, Pulse width t_p limited by T_{jmax} | 418 | A | |
| P _D | Power Dissipation, $T_c = 25^{\circ}C$, $T_j = 175^{\circ}C$ | 416 | W | Fig. 20 |
| T _J , T _{stg} | Operating Junction and Storage Temperature | | °C | |
| TL | Solder Temperature, 1.6mm (0.063") from case for 10s | 260 | °C | |
| M _d | Mounting Torque, (M3 or 6-32 screw) | 1 8.8 | Nm Ibf-in | |

Note (1): Recommended turn off / turn on gate voltage V $_{\rm GS}\,$ - 4V...0V / +15V Note (2): Package limited to 120 A

Package



| Part Number | Package | Marking | |
|-------------|----------|-------------|--|
| C3M0015065D | TO-247-3 | C3M0015065D | |



Electrical Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

| Symbol | Parameter | Min. | Тур. | Max. | Unit | Test Conditions | Note | |
|------------------------|---|------|------|------|-------|--|---------------|--|
| $V_{\text{(BR)DSS}}$ | Drain-Source Breakdown Voltage | 650 | | | V | $V_{GS} = 0 \text{ V}, I_D = 100 \mu\text{A}$ | | |
| M | | 1.8 | 2.3 | 3.6 | V | $V_{DS} = V_{GS}, I_D = 15.5 \text{ mA}$ | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | | 1.9 | | V | $V_{DS} = V_{GS}$, $I_D = 15.5 \text{ mA}$, $T_J = 175^{\circ}\text{C}$ | | |
| I _{DSS} | Zero Gate Voltage Drain Current | | 1 | 50 | μΑ | $V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$ | | |
| I _{GSS} | Gate-Source Leakage Current | | 10 | 250 | nA | $V_{GS} = 15 \text{ V}, V_{DS} = 0 \text{ V}$ | | |
| $R_{\text{DS(on)}}$ | Drain-Source On-State Resistance | 10.5 | 15 | 21 | mΩ | $V_{GS} = 15 \text{ V}, I_D = 55.8 \text{ A}$ | Fig. 4, | |
| DS(on) | | | 20 | | 11132 | $V_{GS} = 15 \text{ V}, I_D = 55.8 \text{ A}, T_J = 175^{\circ}\text{C}$ | 5,6 | |
| g _{fs} | Transconductance | | 42 | | s | V_{DS} = 20 V, I_{DS} = 55.8 A | Fig. 7 | |
| 913 | | | 40 | | | V_{DS} = 20 V, I_{DS} = 55.8 A, T_J = 175°C | | |
| C _{iss} | Input Capacitance | | 5011 | | | | | |
| C _{oss} | Output Capacitance | | 289 | | | | Fig. 17 18 | |
| C _{rss} | Reverse Transfer Capacitance | | 31 | 1 | рF | $V_{GS} = 0 V, V_{DS} = 400 V$ | | |
| C _{o(er)} | Effective Output Capacitance (Energy Related) | | 357 | | | f = 100 Khz V _{AC} = 25 mV | Note | |
| C _{o(tr)} | Effective Output Capacitance (Time Related) | | 516 | | | VAC= 23 111V | Note | |
| E _{oss} | Coss Stored Energy | | 29 | | μ | | Fig. 1 | |
| Eon | Turn-On Switching Energy (Body Diode) | | 1500 | | | $V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_D = 55.8 \text{ A},$ $R_{G(ext)} = 5 \Omega, L = 57.6 \mu\text{H}, T_J = 175^{\circ}\text{C}$ | Fig. 25 | |
| E _{OFF} | Turn Off Switching Energy (Body Diode) | | 700 | | μJ | FWD = Internal Body Diode of MOSFET | | |
| E _{ON} | Turn-On Switching Energy (External Diode) | | 1200 | | | $V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_{D} = 55.8 \text{ A},$ | 1 | |
| E _{OFF} | Turn Off Switching Energy (External Diode) | | 1000 | | μJ | $R_{G(ext)} = 5 \Omega$, L= 57.6 µH, T _J = 175°C FWD = External SiC DIODE | Fig. 2 | |
| $t_{d(\text{on})}$ | Turn-On Delay Time | | 22 | | | | | |
| tr | Rise Time | | 125 | | | $V_{DD} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$ $I_D = 55.8 \text{ A}, R_{G(ext)} = 5 \Omega, L = 57.6 \mu\text{H}$ Timing relative to V _{DS} Inductive load | | |
| $t_{d(off)}$ | Turn-Off Delay Time | | 58 | | ns | | Fig. 2 | |
| t _f | Fall Time | | 25 | | | | | |
| $R_{G(int)}$ | Internal Gate Resistance | | 1.5 | | Ω | $f = 1 MHz$, $V_{AC} = 25 mV$ | | |
| Q_{gs} | Gate to Source Charge | | 54 | | | $V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$ | Fig. 12 | |
| Q_{gd} | Gate to Drain Charge | | 62 | _ | nC | I _D = 55.8 A | | |
| Qg | Total Gate Charge | | 188 | | | Per IEC60747-8-4 pg 21 | | |

Note (3): C_{o(er)}, a lumped capacitance that gives same stored energy as Coss while Vds is rising from 0 to 400V C_{o(tr)}, a lumped capacitance that gives same charging time as Coss while Vds is rising from 0 to 400V



Reverse Diode Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

| Symbol | Parameter | Тур. | Max. | Unit | Test Conditions | Note |
|-----------------------|----------------------------------|------|------|------|---|---------|
| V _{SD} | | | | v | $V_{GS} = -4 \text{ V}, \text{ I}_{SD} = 27.9 \text{ A}, \text{ T}_{J} = 25 \text{ °C}$ | Fig. 8, |
| V _{SD} | Diode Forward Voltage | 4.2 | | v | $V_{_{GS}} = -4 \text{ V}, \text{ I}_{_{SD}} = 27.9 \text{ A}, \text{ T}_{_{J}} = 175 ^{\circ}\text{C}$ | 9, 10 |
| ls | Continuous Diode Forward Current | | 79 | A | $V_{GS} = -4 V, T_C = 25^{\circ}C$ | |
| I _{S, pulse} | Diode pulse Current | | 418 | A | $V_{_{GS}} = -4 V$, pulse width t_p limited by T_{jmax} | |
| t _{rr} | Reverse Recovery time | 85 | | ns | | |
| Q _{rr} | Reverse Recovery Charge | 667 | | nC | $V_{GS} = -4 V, I_{SD} = 55.8 A, V_{R} = 400 V$ dif/dt = 1500 A/µs, T _j = 175 °C | |
| I _{rrm} | Peak Reverse Recovery Current | 17 | | A | | |
| t _{rr} | Reverse Recovery time | 74 | | ns | | |
| Q _{rr} | Reverse Recovery Charge | 562 | | nC | $V_{cs} = -4 V, I_{sD} = 55.8 A, V_{R} = 400 V$ dif/dt = 1000 A/µs, T _j = 175 °C | |
| I _{rrm} | Peak Reverse Recovery Current | 14 | | A | | |

Thermal Characteristics

| Symbol | Parameter | Тур. | Unit | Test Conditions | Note |
|------------------|---|------|--------|-----------------|---------|
| R _{ejc} | Thermal Resistance from Junction to Case | 0.35 | 0C /// | | Fig. 21 |
| R _{0JA} | Thermal Resistance From Junction to Ambient | 40 | °C/W | | Fig. 21 |



Typical Performance

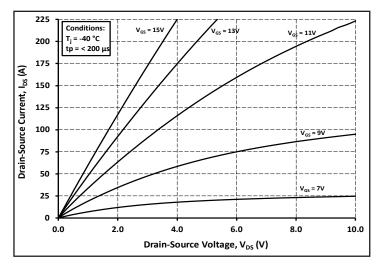


Figure 1. Output Characteristics T_J = -40 °C

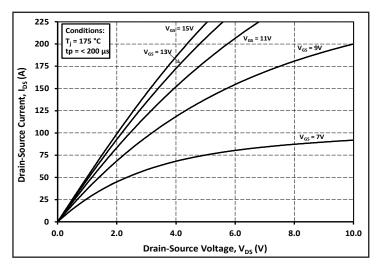


Figure 3. Output Characteristics T_J = 175 °C

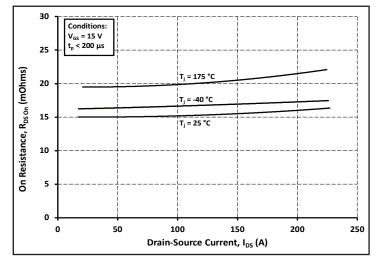


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

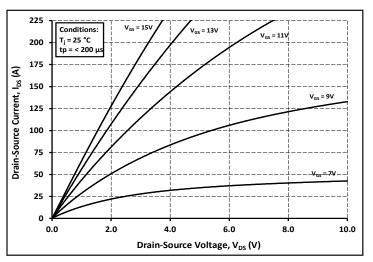
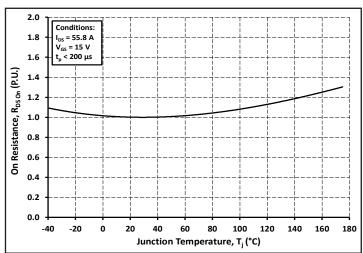


Figure 2. Output Characteristics T_J = 25 °C





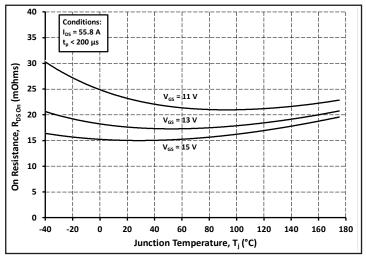
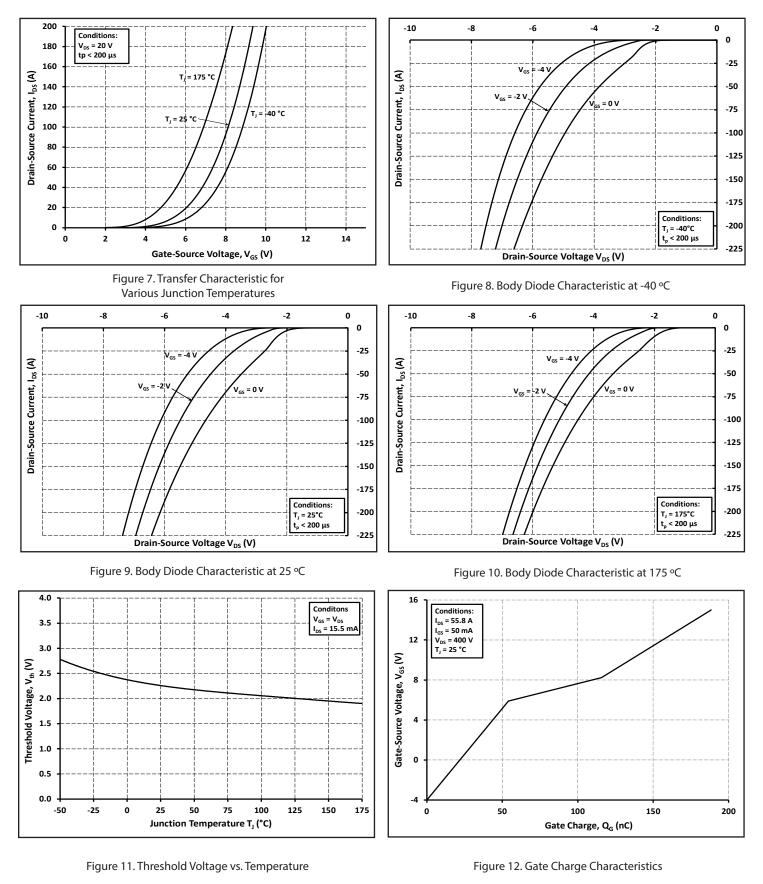


Figure 6. On-Resistance vs. Temperature For Various Gate Voltage



Typical Performance



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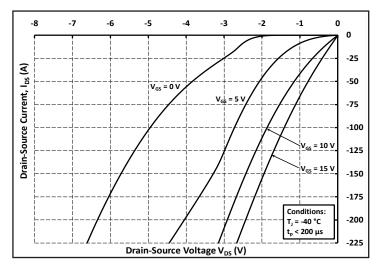


Figure 13. 3rd Quadrant Characteristic at -40 °C

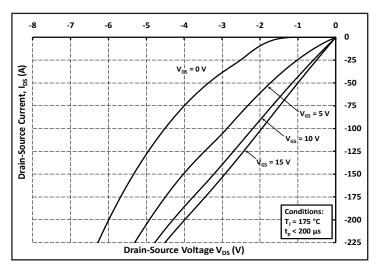
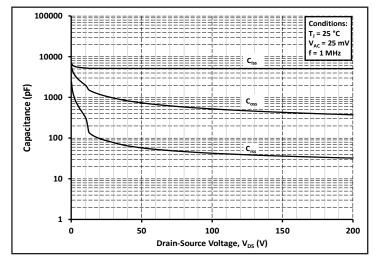
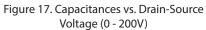


Figure 15. 3rd Quadrant Characteristic at 175 °C





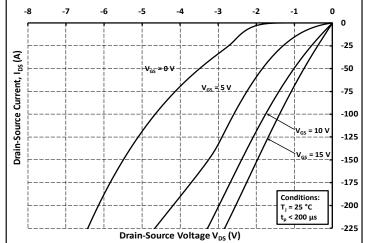


Figure 14. 3rd Quadrant Characteristic at 25 °C

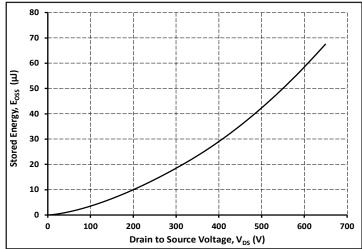


Figure 16. Output Capacitor Stored Energy

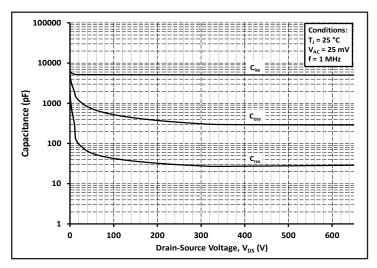
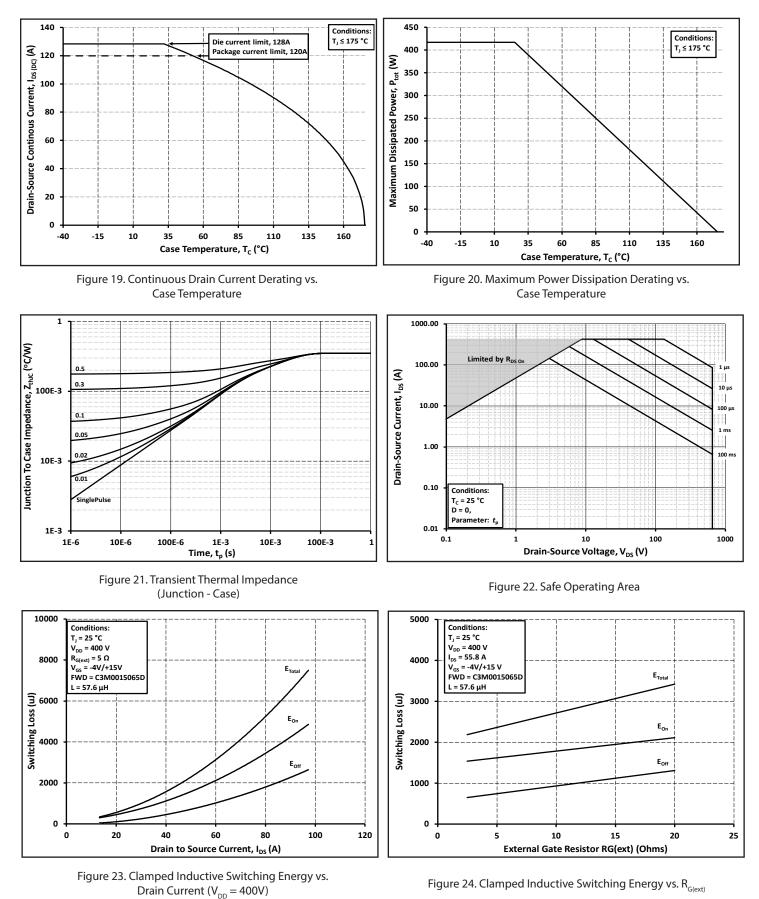


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 650V)



Typical Performance



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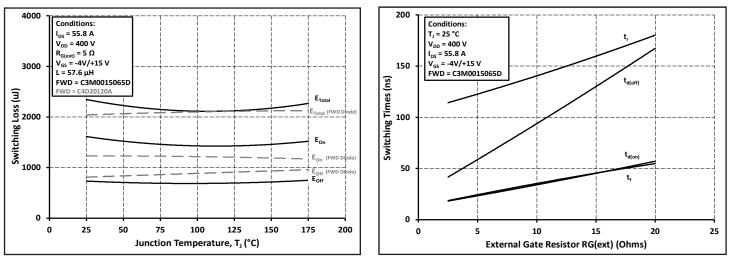


Figure 25. Clamped Inductive Switching Energy vs. Temperature





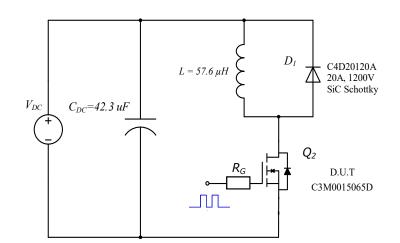


Figure 27. Clamped Inductive Switching Waveform Test Circuit

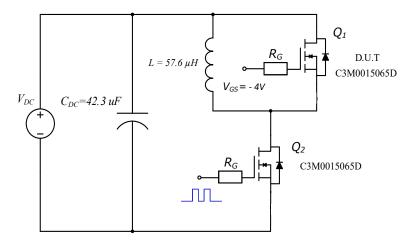
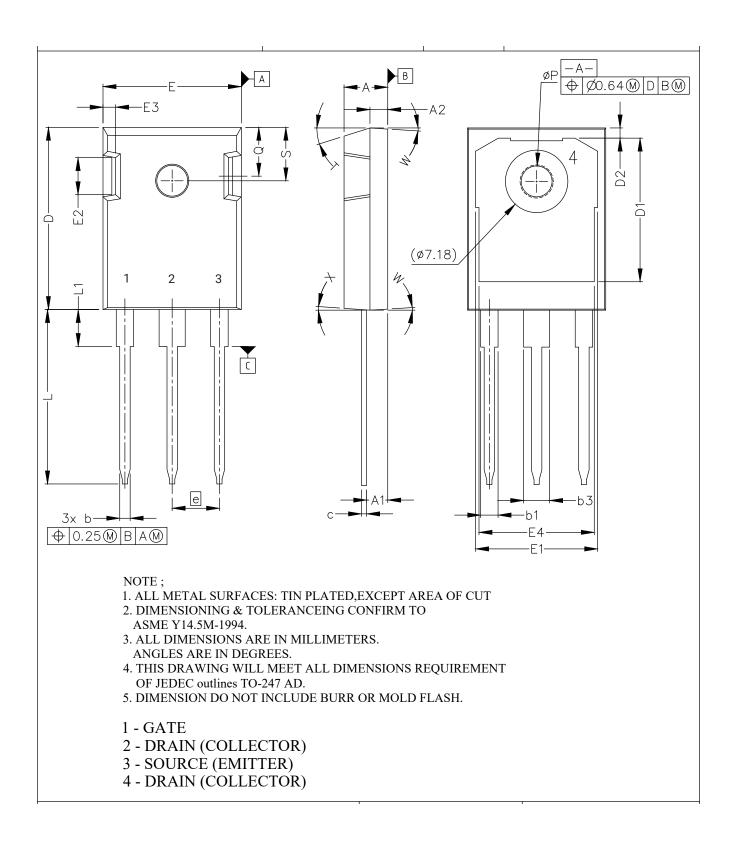


Figure 28. Body Diode Recovery Test Circuit



Package Dimensions

Package TO-247-3



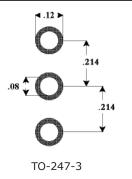
Package Dimensions

Package TO-247-3

| CVAL | MILLIM | ETERS | INC | HES | | |
|------|------------|-------|--------|------|--|--|
| SYM | MIN | MAX | MIN | MAX | | |
| Α | 4.83 | 5.21 | .190 | .205 | | |
| A1 | 2.29 | 2.54 | .090 | .100 | | |
| A2 | 1.91 | 2.16 | .075 | .085 | | |
| b | 1.07 | 1.33 | .042 | .052 | | |
| b1 | 1.91 | 2.41 | .075 | .095 | | |
| b3 | 2.87 | 3.38 | .113 | .133 | | |
| с | 0.55 | 0.68 | .022 | .027 | | |
| D | 20.80 | 21.10 | .819 | .831 | | |
| D1 | 16.25 | 17.65 | .640 | .695 | | |
| D2 | 0.95 | 1.25 | .037 | .049 | | |
| E | 15.75 | 16.13 | .620 | .635 | | |
| E1 | 13.10 | 14.15 | .516 | .557 | | |
| E2 | 3.68 | 5.10 | .145 | .201 | | |
| E3 | 1.00 | 1.90 | .039 | .075 | | |
| E4 | 12.38 | 13.43 | .487 | .529 | | |
| e | 5.44 BSC | 2 | .214 E | BSC | | |
| N | 3 | | 3 | | | |
| L | 19.81 | 20.32 | .780 | .800 | | |
| L1 | 4.10 | 4.40 | .161 | .173 | | |
| ØP | 3.51 | 3.65 | .138 | .144 | | |
| Q | 5.49 | 6.00 | .216 | .236 | | |
| S | 6.04 | 6.30 | .238 | .248 | | |
| Т | 17.5° REF. | | | | | |
| W | 3.5° REF. | | | | | |
| Х | 4° REF. | | | | | |

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Recommended Solder Pad Layout





Notes

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